



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

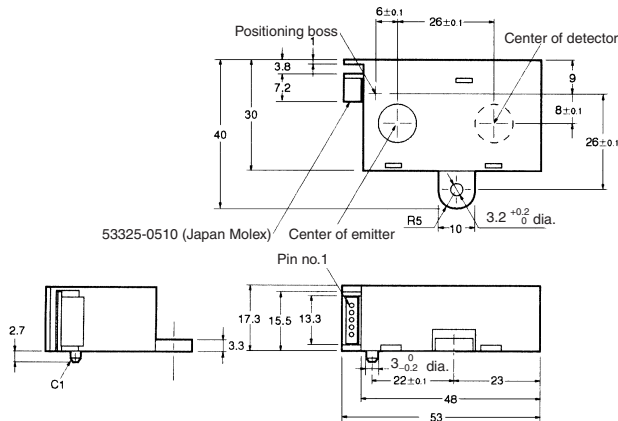
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



# Multiple Beam Sensor (3 Beams: 50 mm) EY3A-3051

## ■ Dimensions

**Note:** All units are in millimeters unless otherwise indicated.



Pin no.	Remarks	Name
1	O1	Output 1 (OUT 1)
2	O2	Output 2 (OUT 2)
3	O3	Output 3 (OUT 3)
4	V	Power supply (Vcc)
5	G	Ground (GND)

Unless otherwise specified, the tolerances are as shown below.

Dimensions	Tolerance
3 mm max.	±0.3
3 < mm ≤ 6	±0.375
6 < mm ≤ 10	±0.45
10 < mm ≤ 18	±0.55
18 < mm ≤ 30	±0.65
30 < mm ≤ 50	±0.8
50 < mm ≤ 80	±0.95

Recommended Mating Connectors:  
Japan Molex 51090-0500 (crimp connector)  
52484-0510 (press-fit connector)

## ■ Features

- Simultaneously senses three objects positioned differently, thus saving space.
- Ensures higher sensitivity and external light interference resistivity than any other photomicrosensor.
- Narrow sensing range ensures stable sensing of a variety of sensing objects.

## ■ Application Examples

Sensing of paper sizes.

## ■ Absolute Maximum Ratings (Ta = 25° C)

Item	Symbol	Rated value	
Power supply voltage	V <sub>CC</sub>	7 V	
Load voltage	V <sub>OUT</sub>	7 V	
Load current	I <sub>OUT</sub>	10 mA	
Ambient temperature	Operating	T <sub>opr</sub>	0° C to 65° C
	Storage	T <sub>stg</sub>	-15° C to 70° C

**Note:** Make sure there is no icing or condensation when operating the Sensor.

## ■ Ordering Information

Description	Model
Multiple beam sensor	EY3A-3051

## ■ Electrical and Optical Characteristics (Ta = 0° C to 65° C)

Item	Value	Condition
Power supply voltage	5 V ±5%	---
Current consumption	50 mA max.	V <sub>CC</sub> = 5 V, R <sub>L</sub> = ∞
Peak current consumption	300 mA max.	V <sub>CC</sub> = 5 V, R <sub>L</sub> = ∞
Low-level output voltage	0.6 V max.	V <sub>CC</sub> = 5 V, I <sub>OL</sub> = 4 mA (see note 1)
High-level output voltage	3.5 V min.	V <sub>CC</sub> = 5 V, R <sub>L</sub> = 4.7 kΩ (see note 2)
Response delay time (high to low)	35 ms max.	The time required for the output to become "Lo" after placing sensing object.
Response delay time (low to high)	20 ms max.	The time required for the output to become "Hi" after removing sensing object.

- Note:**
1. These conditions are for the sensing of lusterless paper with an OD of 0.8 maximum located at the correct sensing position of the Sensor as shown in the optical path arrangement on the next page.
  2. These conditions are for the sensing of the paper supporting plate with an OD of 0.05 located using the glass plate without paper as shown in the optical path arrangement on the next page.

**■ Characteristics (Paper Table Glass: t = 6 mm max., Transparency Rate: 90% min.)  
(Ta = 0°C to 65°C)**

Item	Characteristic value
Sensing density	Lusterless paper with an OD of 0.8 max. (sensing distance: 50 mm) (see note)
Non-sensing distance	80 mm (from the top of the sensor), OD: 0.05
Paper sensing distance	50 mm (from the top of the sensor)
Ambient illumination	Sunlight: 3,000 lx max., fluorescent light: 2,000 lx max.

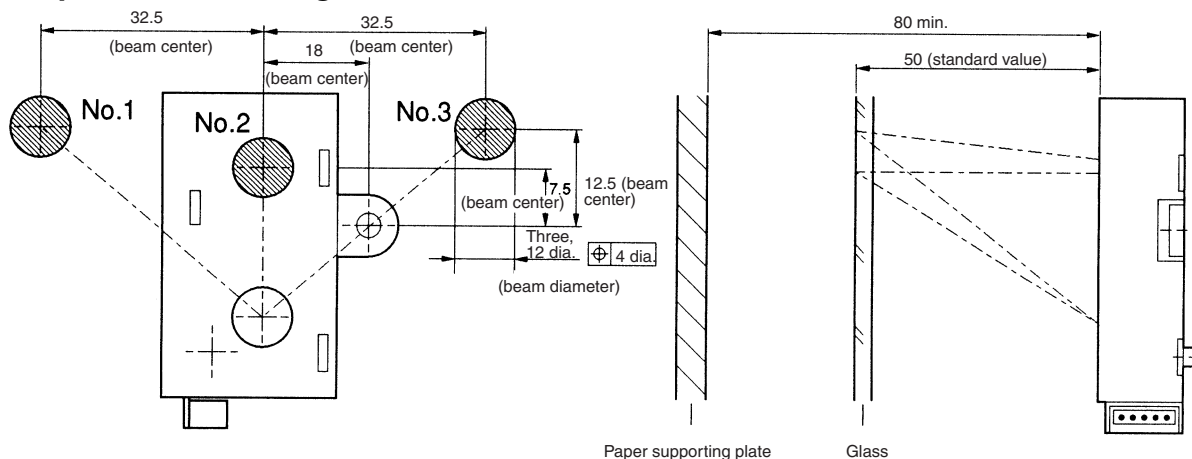
- Note:** 1. The data shown are initial data.  
2. Optical darkness (OD) is defined by the following formula:

$$OD = -\log_{10} \left( \frac{P_{OUT}}{P_{IN}} \right)$$

P<sub>IN</sub> (mW): Light power incident upon the document

P<sub>OUT</sub> (mW): Reflected light power from the document

**■ Optical Path Arrangement**



**■ Engineering Data**

**Distance Characteristics (Estimated Lower-limit Value)**

